# **Tyrone Camarero Specifications**

## Camarero-SDI200C3S-316H

### **Key Feature**

Enterprise Server, iSCSI SAN, HPC, Data Center, Database Processing & Storage, Corporate Database, Appliance Optimized Storage Building **Blocks** 

- Dual Socket E (LGA-4677), 5th Gen Intel® Xeon® / 4th Gen Intel® Xeon® Scalable
- 16 DIMM slots, Max Memory (1DPC): Up to 4TB 5600MT/s ECC DDR5 RDIMM
- 1x GbE Dedicated LAN for server remote management: IPMI 2.0 / KVM over LAN / Media over LAN
- 2x 10 GbE onboard via Broadcom BCM57416
- 16 front hot-swap 3.5" SAS/SATA drive bay(s), 2 rear hot-swap 2.5" SATA drive bay(s)
- 5x 8cm hot-swap counter-rotate redundant PWM cooling fans
- 800/1000W /1200W Redundant Titanium Level power supplies
- HW RAID support







#### Processor/Cache

Dual Socket E (LGA-4677), 5th Gen Intel® **Processor** 

Xeon® / 4th Gen Intel® Xeon® Scalable

Supports 120W - 270W TDP CPUs (Air Note

#### System Memory

Memory 16 DIMM slots,

Max Memory (1DPC): Up to 4TB Capacity

5600MT/s ECC DDR5 RDIMM

Chipset

Chipset Intel® C741 chipset

**Expansion Slot** 

**PCI-Express** 2 PCle 5.0 x8 LP slot(s), 4 PCle 5.0 x16 LP

slot(s)

Note PCIe slot 1 & 2 are occupied by the Storage

Controller/JBOD Expansion Module

**Integrated Onboard:** 

**SATA** Network Connectivity :2x 10GbE BaseT with

Broadcom BCM57416

1 RJ45 Dedicated IPMI LAN port, 2 Onboard LAN

10 GbE LAN Ports

Add-on Options

**Raid Card** None Optical

Drive

None

Front Panel

LED HDD activity, Network activity, Power

status, System information

(overheat/UID)

**Buttons** Power On/Off

Drive bays

**HDD Bays** 16 front hot-swap 3.5" SAS/SATA drive

bay(s), 2 rear hot-swap 2.5" SATA drive

bay(s)

**Power Supply** 

**Power Supply** 800/1000W /1200W Redundant

Titanium Level power supplies

**Cooling System** 

Fans 5 Heavy Duty 8cm Fan(s)

Form Factor

Form Factor 3U Rackmount

**Dimensions** 

**Dimensions** Dimensions: Height - 5.2", Width- 17.2",

Depth -25.5

Email: Info@tyronesystems.com For more/current product information, Visit www.tyronesystems.com

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